

# Affordable Transient Protection

## Filter Connectors with Multilayer Planar Varistor Arrays

### 1 Introduction

*"Connectors contribute nothing to electronic equipment", a contentious statement that was bound to raise a few hackles even when originally written but, now, undisputedly wrong!*

A modern connector, in isolation, can fulfil the equipment protection function - both against continuous and transient noise.

*"But what about cost? - add filtering and a \$10 connector becomes a \$100 connector - add protection against voltage spikes and you are looking at a \$1,000 connector!"*

May be so but *"times, they are a-changing"*. The ultimate Filter Capacitor, the Multilayer Planar Array is now available with an additional function, that of transient protection.

Built using Multilayer Varistor Planar Arrays, Transient Protection Filter Connectors are about to become an affordable commodity.

### 2 Varistors

Varistors are Variable Resistors. At low values of applied voltage, a Varistor acts as a conventional high value Resistor obeying Ohms Law but, above a threshold voltage, the device becomes highly conductive presenting a low impedance to high voltages.

When the Varistor becomes conductive, it clamps the applied voltage to a specified maximum that the protected system can withstand.

With these properties, Varistors are employed in electrical applications to protect circuitry from momentary over-voltages.

At low voltages, Varistor behaviour resembles that of a ceramic Capacitor and as such, it can could also act as part of an electrical Filter, a countermeasure to continuous noise.

So why were Varistors not regularly used in Filter applications, where they could fulfil a dual role - that of continuous noise attenuation and transient voltage suppression?

### 3 Varistor Pulse Ratings

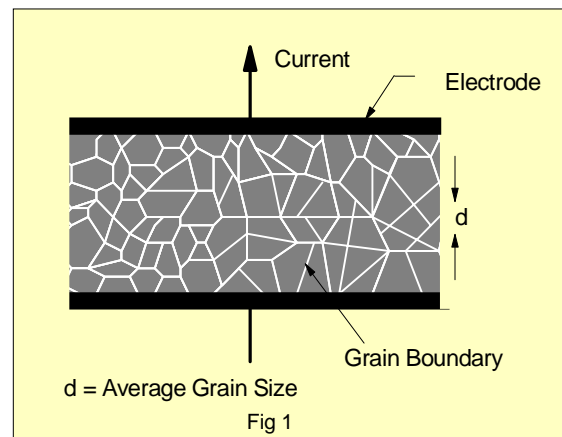
One of the reservations on the part of potential users over the use of Varistors in filter applications concerned a degradation of protection that might occur as a result of repeated strikes by voltage surges.

Varistors are made from ceramic materials. The predominant Varistor type has a main component which is Zinc Oxide (ZnO). To this are added small amounts of other oxides such as Bismuth, Cobalt, Manganese and others. Accordingly, Varistors are sometime known as Metal Oxide Varistors or MOVs.

During manufacture, original ceramic powders are mixed and shaped then fired. Metallization is applied to afford an electrical

connection.

During the firing of the ceramic, a multicrystalline structure is formed. Figure 1. The metal oxide additives move to the boundaries of the grains where they form semiconducting layers, P-N junctions. The mean grain size is determined by the original powder formulation and the firing temperature.



Below an applied voltage stress of around 3.6 volts per grain boundary, the grain boundaries are highly resistive. Above that threshold, they switch and become highly conductive.

The voltage at which the Varistor, itself, switches is determined by the average number of grains between the electrodes of the part.

The crystal structure of a Varistor has no directionality therefore Varistors are bi-polar devices. With symmetrical, sharp voltage breakdown characteristics, they exhibit an electrical behaviour similar to back-to-back Zener Diodes.

Traditionally, Varistors were reputed to suffer a degradation of electrical performance as a result of repeated pulsing at high current levels (notably a decrease in their clamping performance and an increase in their Leakage Current).

At one time, the manufacture of Varistors demanded the use of large grain size ceramic formulations. Large grain sizes resulted in fewer grain boundaries per unit area of electrode and longer current paths, via the grain boundaries, between electrodes. Series Resistance per unit area of electrode was relatively high resulting in a commensurately low peak current capability.

The need to produce a genuine surface mountable chip Varistor configuration that could operate at low voltage demanded the development of fine grain ceramic formulations that would be capable of successful fabrication in a Multilayer format.

This done, these small and uniform grain size materials, coupled with the high electrode area relative to the component

platform provided by the Multilayer format, resulted in massive increases in peak current capability per unit of component volume.

Current and Energy Ratings for Multilayer Varistors (MLVs) are very conservative compared with those for other Varistor types and now it can be demonstrated that MLVs can survive many thousands of strikes, at full rated peak current, without degradation.

#### 4 Speed & Overshoot

As the manufacturers of components of various transient protection technologies sought to press their case for adoption of their preferred products, speed of response, or lack thereof, was often raised as a concern over Varistors.

The base material of Varistors has a response time of much less than 500 Pico-seconds.

What contributed to 'slow response times' on the part of early Varistor components was the parasitic inductance of their finished package.

With 25 to 50 mm of wire used in their construction, at an inductance of 0.6 nH per mm, high levels of self inductance were a feature of Radial Lead Varistors.

Multilayer construction has eliminated lead wire and, now, with a typical inductance of the order 1,200 pH, a 1206 MLV chip has a response time of less than 1 nS.

Other component configurations, pioneered as Filter Capacitor structures, are becoming available as Varistors - with Equivalent Series Inductances (ESLs) as low as 30 pH, these afford the opportunity for response times down to a few tens of picoseconds.

Another issue created by the inductance inherent in the construction of leaded Varistors was Voltage Overshoot.

Change of current ( $di/dt$ ) would, as a result of the Varistor self inductance ( $L$ ), generate a voltage equal to  $-Ldi/dt$ .

During a voltage spike, across the Varistor would appear the sum of the clamp voltage plus a voltage induced as a result of the Varistor inductance.

Reduction of the self inductance of MLV Filter structures down to a few 10s of pH has all but eliminated any concern over voltage overshoot.

#### 5 EMI Filters

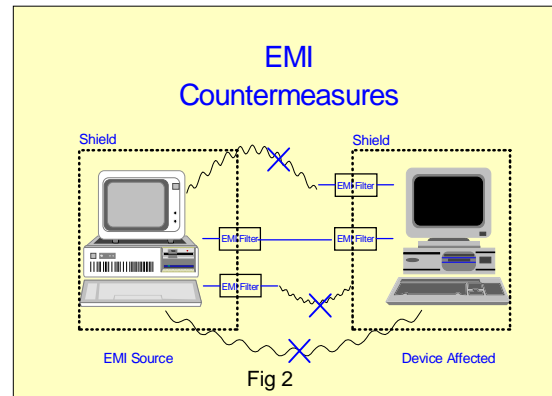
The effective counter to radiation is shielding. Radiated noise energy is absorbed by the shielding and dissipated as heat.

The effective measure against conduction is the EMI Filter, which diverts conducted energy away from the protected system to ground. Figure 2.

EMI Filters are constructed from combinations of Capacitors and Inductors utilising their different impedance characteristics to reduce unwanted signals, selectively.

They are bi-directional - at the same time as they keep unwanted noise out of a system, they also prevent that system from emitting noise.

Whilst assembly of filters on the circuit boards of the equipment is relatively common practise, filters are most effective when placed at the point of exit and entry of cable from the equipment shielding.

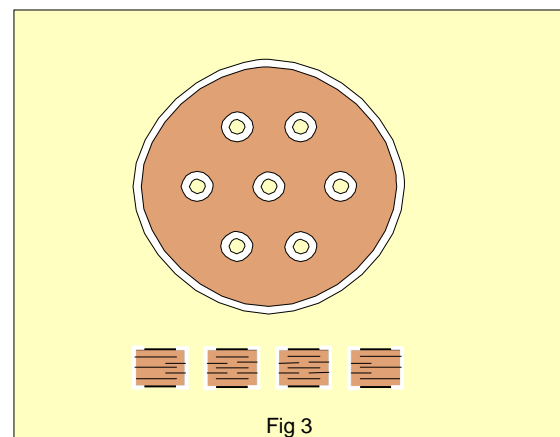


A connector enables grouping of power and signal cables so that all enter the equipment shielding at a single point. Within the connector, at each contact, a filter circuit can be formed, and these may be C,T, L or Pi configurations according to the demands of the system.

The Filter Connector affords a reduction in overall system size and weight as it all but eliminates the need for board level Filter circuits. System reliability is improved as the number of solder joints is reduced.

#### 6 Multilayer Planar Capacitor Arrays

The Multilayer Planar Array is an application specific component designed for use in EMI Filter connectors. It is a unitary block of ceramic, containing a multiplicity of capacitors. Individual line connection is made, to each capacitor, through a via hole whilst ground connection is made to all at the device perimeter. Very low impedances are encountered as signals are presented with multi-directional paths to ground. Figure 3.



Each contact of the connector is connected to holes in one or more arrays. At each hole there is a Capacitor - 'hot electrodes' make connection with the hole perimeter whilst ground electrodes cover the entire Planar and make contact with the Connector shell through the Planar perimeter. Figure 4.

Planar based Filter Connectors are available in all MIL-STD Connector layouts. Connector shapes (to which the outlines of Planar Arrays must conform) are either circular or rectangular. Popular rectangular layouts include D-Sub, High Density D-Sub, Micro D's and Nano D's, Arinc 404's and Arinc 600's. Irregular shapes are also available.

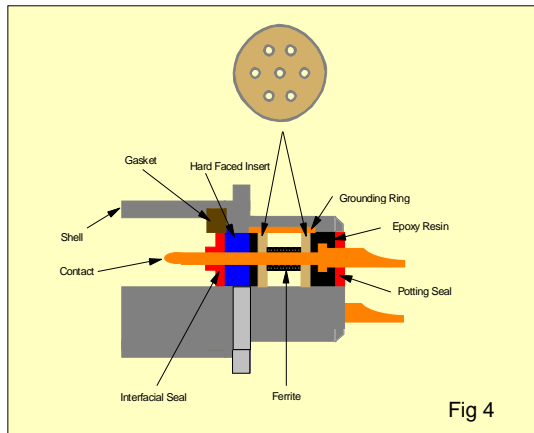


Fig 4

The corresponding Planars range in size from around 5 mm square to over 75 mm in diameter.

Contact counts range from 2 to 200 plus. Standard contacts range from 0.3 mm diameter upwards to co-ax - all can be filtered. Standard contact pitchings start at 0.63 mm.

Within the Planar Array, as many as 6 different capacitance values may be distributed about the layout without regard to any artificial ratios. Different operating voltages may be specified across a Planar and a typical 300 v dc rated Planar will withstand transients of up to 750 v peak. A transient capability of up to 3,000 v may be specified.

Individual holes can be isolated (Feed Thru's) or grounded. Maximum Ground Plane Resistances of 10 mΩ can be specified and Cross Talk Capacitance can be restricted to 10 pF or less

The sophistication of the Planar Array lies not in the complexity of electrical specifications that can be incorporated into a single component but in the mechanical precision with which such devices must be built.

Typically, pin positions in a Connector must be maintained to better than ± 0.05 mm so Planar Arrays must be built to the same or better mechanical tolerances.

Planars must be formed (shaped and drilled) before ceramic firing, during which they shrink, typically by around 20%. Pin positions on a 30 mm fired diameter Planar will move more than 2.5 mm during firing relative to a central reference point - that is 50 x the magnitude of the permissible pin position tolerance!

The Planar Array is one of the most advanced passive components. With multiple Capacitors per device, multiple capacitance values per device, and multiple electrical function alternatives per hole, it was one of the original Integrated Passive Components.

Few Capacitor manufacturers have a capability of making such a device - only a handful of companies worldwide claim that ability. Syfer Technology Ltd. is acknowledged to be the World's leading manufacturer of Multilayer Planar Capacitor Arrays.

## 7 Multilayer Varistor Planar Arrays.

At low voltages, Multilayer Varistors behave like Capacitors. Grain Boundaries are insulators and have dielectric properties.

The effective Dielectric Constant of an MLV is around 800, i.e. about one quarter to one third of the value of a typical X7R Multilayer Capacitor dielectric. Capacitance values available from Varistors are commensurately lower than may be obtained from conventional Capacitors.

Given that these are at the low end of what can be achieved by conventional Multilayer Capacitor technology, value for value, the filter performance of an MLV is virtually indistinguishable from that of a capacitor.

When used in a filter application, a Varistor provides an additional Transient Protection Function. It dissipates the energy contained in transient voltage pulses as heat. Figure 5.

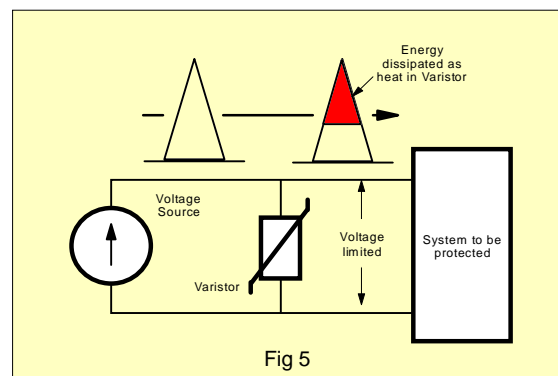


Fig 5

The highly conductive ZnO grains act as heat sinks ensuring a rapid and even distribution of the thermal energy throughout the device, minimising temperature rise.

*[Varistors, however, can only dissipate a relatively small amount of average power and are unsuited to applications which demand continuous power dissipation.]*

Given that they can be built in a Multilayer structure, there is no Multilayer Capacitor component configuration that cannot be duplicated as a Varistor and Syfer Technology Limited now makes Varistors available in a Planar Arrays format.

These sophisticated components are intended, exclusively, for incorporation into protected EMI Filter Connectors (both Plug and Receptacle) and Filter Adaptors. They can replace or supplement capacitors in C, L, T or Pi Filter configurations. Figure 6.

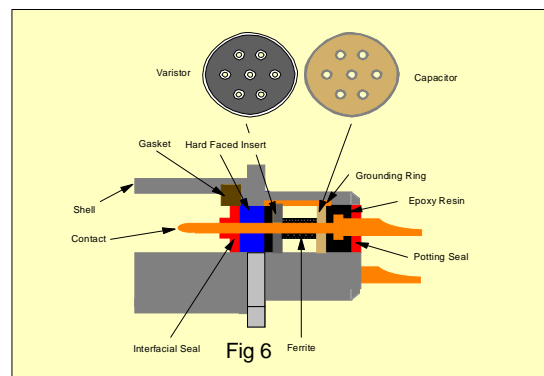


Fig 6

Filter Connectors which include additional transient protection have, hitherto, been made available using two other Transient Voltage Suppression technologies...

and... Tubular Varistors  
Zener Diodes.

Compared with a planar based Filter Connector, both technologies demand a longer (and therefore heavier) Filter Connector shell.

Both make for less efficient use of Connector real estate - neither technology can compete with Planars in terms of Connector pin density.

Each of the other components must be handled individually during the Connector assembly process and neither affords a compensation for this cost burden by way of a low piece part cost.

Varistor Planar Arrays are available from Syfer Technology Limited in all MIL-STD layouts including both circular and rectangular layouts.

Within the Array, as many as 3 different voltage values may be distributed about the layout. Rated Voltages range from 5 to 70 volts dependent upon pin density. Capacitance values are up to 6,000 pF and multiple capacitance values may be specified. Surge currents of up to 1,000 amps are a capability and Surge Energies of over 2 J may be accommodated.

Individual holes can be grounded but Ground Plane Resistances will tend to be higher than those of similar Capacitor Arrays as the Resistivity of the electrode material (Pt) is higher and electrodes are generally fewer.

Where required, holes can be electrically isolated for use as feed thru's. *[It should be born in mind that a Varistor action will occur at a feed thru' hole if the filter pin is allowed to touch the hole bore so pins at feed thru' holes should be sleeved or otherwise electrically insulated from the planar.]*

## 6 Summary

Affordable Transient Protection is now available within electronic connectors.

The Varistor Planar Array based Transient Protected Filter Connector offers a reduction in overall system size and weight as it all but eliminates the need for board level Filter and Suppression circuits. System reliability is improved.

The Varistor Planar Array is now the most sophisticated passive component. Affording transient protection at different voltages across different holes, multiple capacitance values per device, and other electrical function alternatives per hole, it is the ultimate Integrated Passive Component.

Syfer Technology Ltd. is the World's only manufacturer of Transient Protection Planar Arrays.